

## C0805X362KATACTU

Aliases (C0805X362KATAC7800) SMD Comm X8G HT150C Flex, Ceramic, 3,600 pF, 10%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0805, 0.6 mm



Click here for the 3D model.

General Information	
Series	SMD Comm X8G HT150C Flex
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable
Features	High Temperature, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	13 mg
Shelf Life	78 Weeks
MSL	1

Time is 1000 Hours

100 GOhms

	Specifications	
	Capacitance	3,600 pF
/-0.3mm	Measurement Condition	1 kHz 1.0Vrms
n +/-0.3mm	Tolerance	10%
+/-0.10mm	Voltage DC	250 VDC
MIN	Dielectric Withstanding Voltage	625 VDC
+/-0.25mm	Temperature Range	-55/+150°C
	Temp. Coefficient	X8G
Omm, Plastic Tape	Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
	Dissipation Factor	0.1%1 kHz 1.0Vrms
	Aging Rate	0% Loss/Decade Hour: Referee

Insulation Resistance

 Dimensions

 Chip Size
 0805

 L
 2mm +/-0.3mm

 W
 1.25mm +/-0.3mm

 T
 0.9mm +/-0.10mm

 S
 0.6mm MIN

 B
 0.5mm +/-0.25mm

## Packaging Specifications Packaging

Packaging	T&R, 180m	nm, Plastic Tape
Packaging Quantity	4000	